

## 2018 Buckeye Clay Bash Scholarship Application

**DEADLINE DATE: November 30, 2018**

**Four scholarships for half the registration fee** for the 2018 Buckeye Clay Bash are being offered this year – two for the Dayton Guild and two for the Columbus Guild.

Should one Guild not have two applicants by the above deadline, the unused scholarship(s) will be offered to a member(s) of the other Guild.

**Application is on the honor system** – we ask that you not request a scholarship unless the registration fee presents a genuine financial hardship.

Recipients will be **selected by random draw** the first week in December 2018 and will be notified that week.

For privacy reasons, **all applicants will be notified individually** as to their status immediately after the drawing, and all communications regarding applications and recipients will be confidential.

Applicant's Name: \_\_\_\_\_

Address: \_\_\_\_\_

Email address: \_\_\_\_\_

Phone number: \_\_\_\_\_

Member of: \_\_\_\_\_ CPCG      \_\_\_\_\_ DAPCG      (Please choose only one)

This application is **due on or before November 30, 2018** and should be mailed or emailed to:

Jan VanDonkelaar  
633 McBee Road  
Bellbrook, Ohio 45305

[email: clay4me55@gmail.com](mailto:clay4me55@gmail.com)